3-Channel Constant Current Driver

Product Description

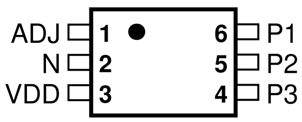
The SCT2001 is designed to drive multiple LEDs in series from a high input voltage rail. The SCT2001 contains three output channels which are regulated to sink constant current for driving LEDs of large range forward voltage (V_F) variations.

In applications, users can simply adjust the sink current from 10 mA to 45 mA through an external resistor RADJ to control the light intensity of LEDs. The SCT2001 guarantees to endure maximum DC 24V at each channel.

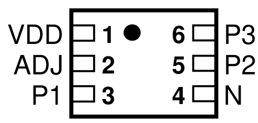
Features

- Three constant-current outputs rate at 24V
- Constant current range:10 – 45mA
- Wide operating operation by adding resistor from supply voltage
- ±2%(typ) current matching between outputs
- ±4%(typ) current matching between ICs
- Smart dimming control via ADJ pin
- Low drop-out output 0.3V@20mA
- Excellent current regulation to load, supply voltage and temperature
- All output current are adjusted through one external resistor
- Hysteresis input for ADJ external resistor
- Built-in power on reset and thermal protection function
- Package: Small 2mmx2mm DFN and SOT-236
- Applications: Mini light bar, LED backlight, LED lamp

Pin Configurations



SOT-236



DFN6

Terminal Description

Pin No.		Pin Name	Function
SOT-236	DFN6		
1	2	ADJ	Input terminal used to set up all input current
2	4	N	Current output / Ground terminal
3	1	VDD	Supply voltage terminal
4	6	P3	Current input terminal 3
5	5	P2	Current input terminal 2
6	3	P1	Current input terminal 1

Ordering information

Part	Marking	Package	Unit per reel(pcs)
SCT2001AS1G	2001	Green SOT-236	3000
SCT2001ADNG	01A	Green DFN6	3000

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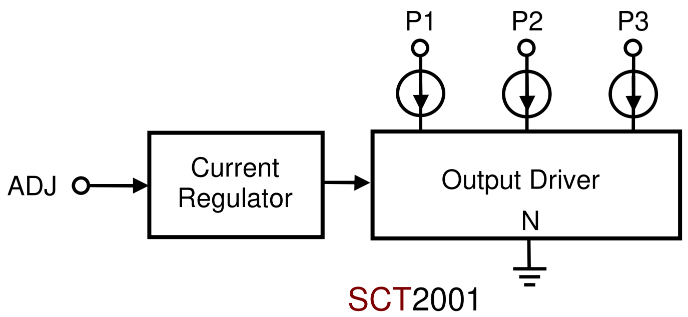
Block Diagram



Maximum Ratings (T_A = 25°C)

Characteristic		Symbol	Rating	Unit
Supply voltage(DC)		V_{DD}	24	V
Input voltage		V_{ADJ}	-0.4 ~ V_{DD}+0.4	V
Output current		I_{PN}	60	mA
Output voltage		V_P	24	V
Total output current		I_N	200	mA
Power dissipation (on PCB)	SOT-236	P_D	0.64	W
	DFN6		2.16	
Thermal resistance (on PCB)	SOT-236	$R_{TH(j-a)}$	195	°C /W
	DFN6		58	
Operating temperature		T_{OPR}	-40~+85	°C
Storage temperature		T_{STG}	-55~+150	°C

The absolute maximum ratings are a set of ratings not to be exceeded. Stresses beyond those listed under "Maximum Ratings" may cause the device breakdown, deterioration even permanent damage. Exposure to the maximum rating conditions for extended periods may affect device reliability.

Recommended Operating Conditions (T_A= -40 to 85°C unless otherwise noted)

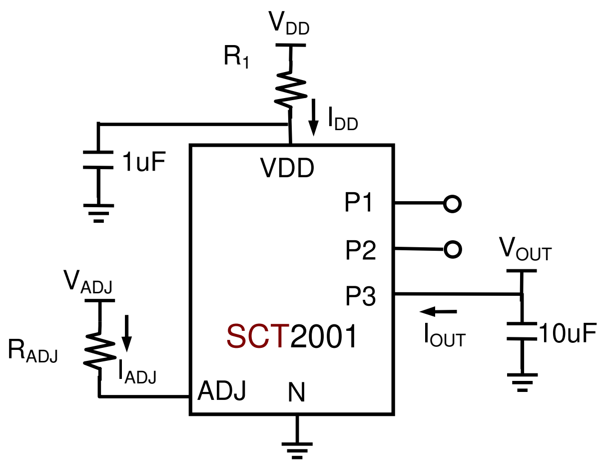
Characteristic	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply voltage(DC)	V_{DD}	-	5	-	24	V
Output voltage	V_P	Current OFF	-	-	24	V
		Current ON	-	1	4	V
Output current	I_{PN}	DC test circuit	10	-	45	mA
Dimming pulse width	t_W	V_{DD}=5-24V	2	-	-	us
Dimming rise time	t_R	V_{DD}=5-24V	-	-	1	us
Dimming fall time	t_F	V_{DD}=5-24V	-	-	1	us

1. *The output current keep constant in range of 10-45mA if V_{OUT}=1V.User can minimize V_{OUT} to reduce power dissipation according to used current, e.g., set V_{OUT} to 0.3V if I_{OUT}=20mA.*
2. *The maximum V_P is package thermal limited, user should keep V_P under maximum power dissipation.*

Electrical Characteristics (V_{DD}=5-24V, V_{ADJ}=5V, R_1=2K, T_A=25°C unless otherwise specified)

Characteristic	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply current	I_{DD}	V_{DD}=5, R_1=2K	-	1	1.5	mA
ADJ input voltage	V_{IH}	-	2.5	-	-	V
	V_{IL}	-	-	-	20	mV
ADJ input current	I_{ADJ}	V_{ADJ}=5V, R_{ADJ}=4.8K	-	1	-	mA
Output leakage	I_{PNL}	V_{ADJ}=0V, V_P=24V,	-	-	0.5	uA
Output current	I_{PN}	R_{ADJ}=4.8K	-	20	-	mA
Current channel skew	dI_{PN1}	V_P=1V,R_{ADJ}=4.8K	-	±2	±3	%
Current chip skew	dI_{PN2}	V_P=1V,R_{ADJ}=4.8K	-	±3	±4	%
Line regulation I_{PN} vs. V_{DD}	%/dV_{DD}	5V < V_{DD} < 24V, R_1=2K V_P>1 V, R_{ADJ}=4.8K	-	-	±1	%/V
Load regulation I_{PN} vs. V_P	%/dV_P	1V < V_P < 4V, I_{PN}=20mA, R_{ADJ}=4.8K	-	-	±1	%/V
Thermal shutdown	T_H	Junction Temperature	-	160	-	°C
	T_L		-	110	-	°C

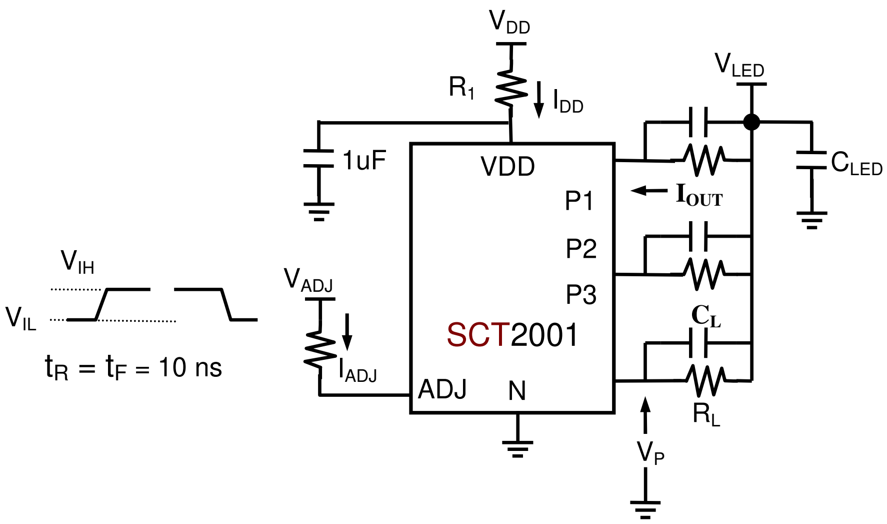
Test Circuit for Electrical Characteristics



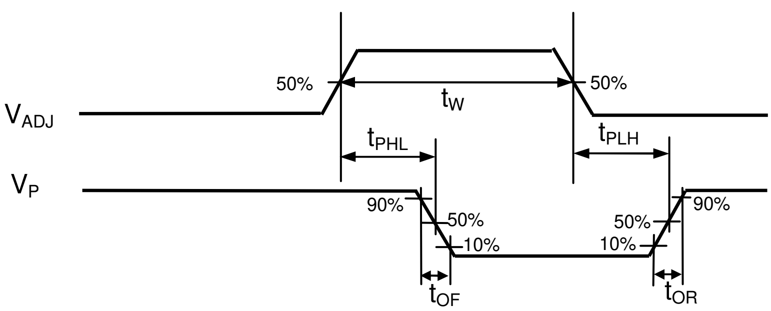
Switching Characteristics (V_{DD}=5-24V, R_1=2K, T_A=25°C unless otherwise noted)

Characteristic		Symbol	Conditions	Min.	Typ.	Max.	Unit
Propagation delay time ("L" to "H")	$V_{ADJ} - V_P$	t_{PLH}	V_{LED} = 5V V_{IH} = 5V V_{IL}= GND V_{ADJ}= 5V R_{ADJ} = 4.8KΩ R_1 = 2KΩ C_1 = 1uF R_L = 180Ω C_L = 10pF C_{LED} = 47uF	-	200	400	ns
Propagation delay time ("H" to "L")	$V_{ADJ} - V_P$	t_{PHL}		-	200	400	ns
Pulse width	V_{ADJ}	t_w		2	-	-	us
Output rise time of I_{PN}		t_{OR}		-	200	400	ns
Output fall time of I_{PN}		t_{OF}		-	200	400	ns

Test Circuit for Switching Characteristics

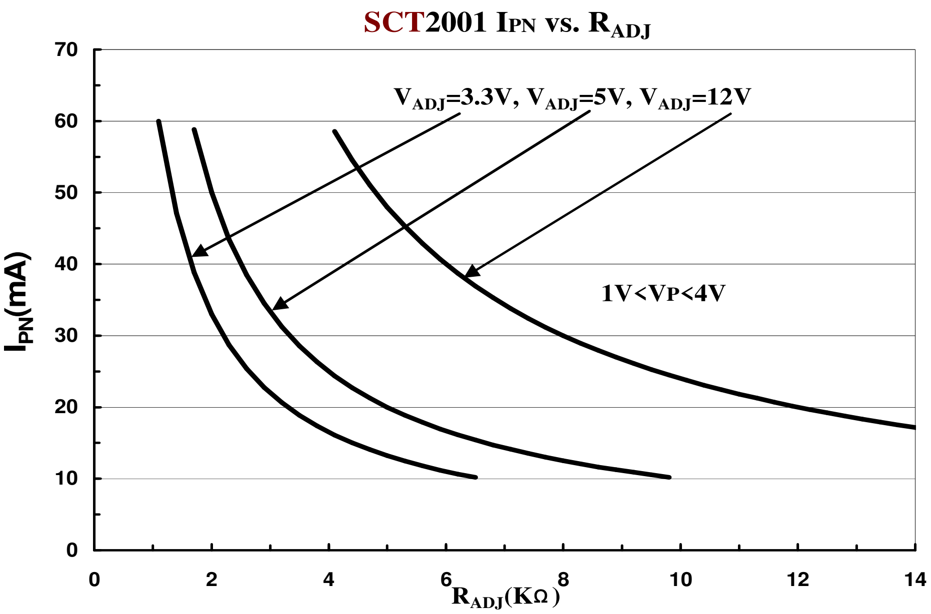


Timing Waveform



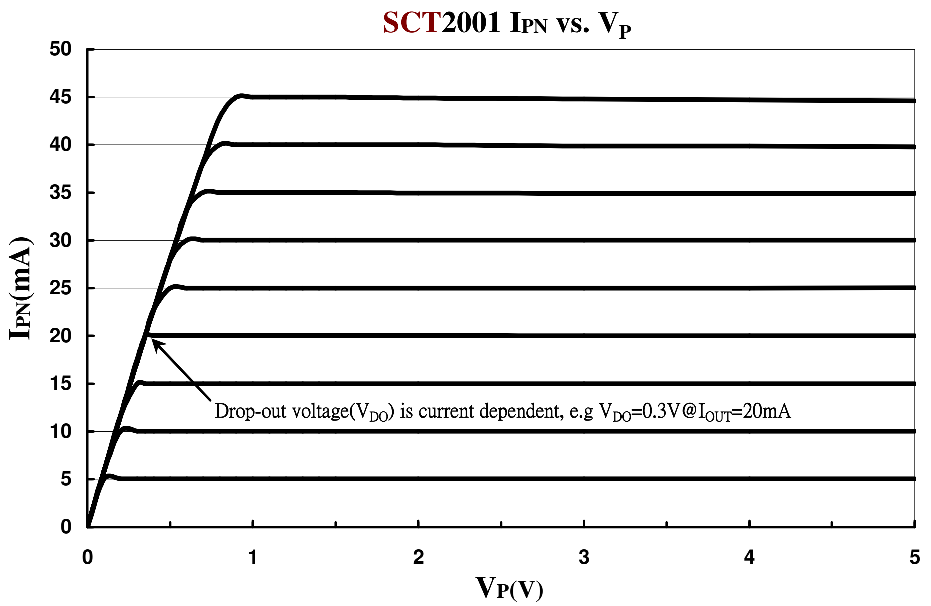
Adjusting Output Current

The sink current (I_{PN}) are set by one external resistor at pin ADJ. The relationship between I_{PN}, resistance R_{ADJ} and reference voltage V_{ADJ} is shown as the following figure. V_{ADJ} connected to a stable reference voltage is suggested. Furthermore, I_{PN} could be estimated by I_{PN} (mA) = 20*V_{ADJ} / (R_{ADJ} (KΩ) + 0.2)



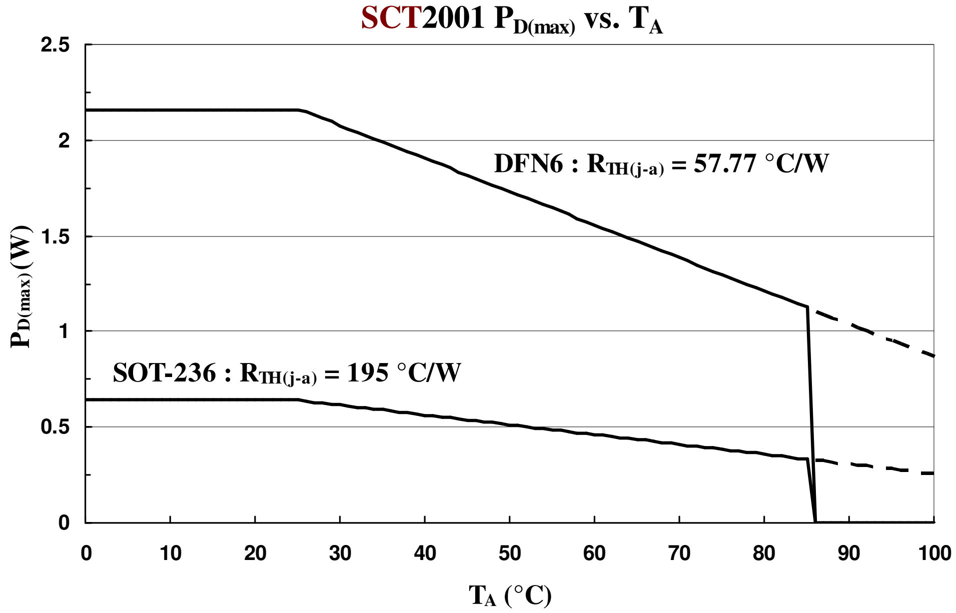
Output Characteristics

The current characteristic of output curve is flat. The output current can be kept constant regardless of the variations of LED forward voltage when $V_P > V_{DO}$(drop-out voltage). The relationship between I_{PN} and V_P is shown below. The output voltage should be kept as low as possible to prevent the SCT2001 from being overheated.



Power Dissipation

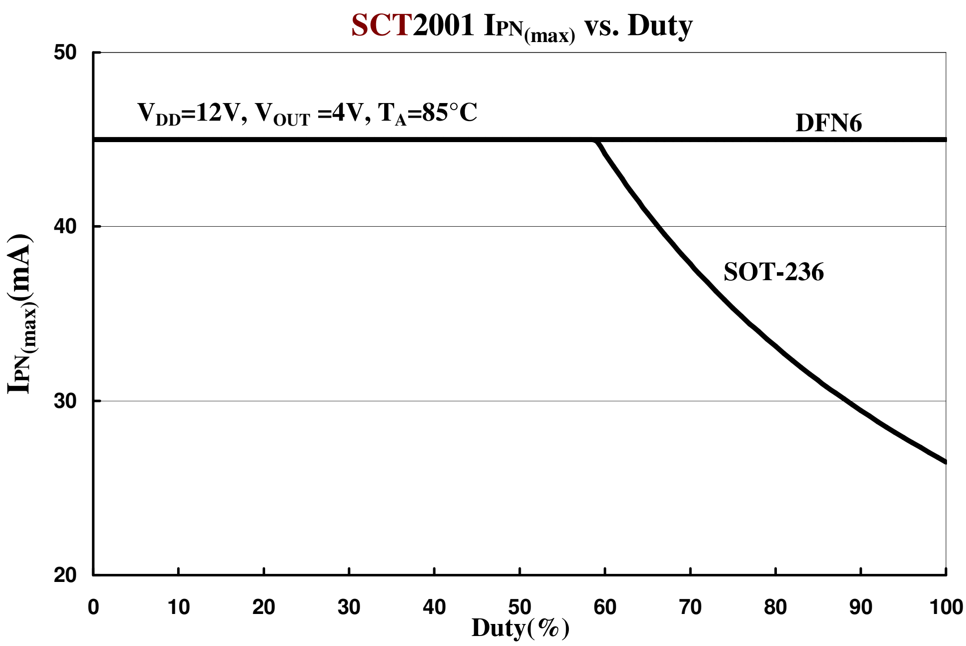
The maximum power dissipation ($P_{D(max)}$) of a semiconductor chip varies with different packages and ambient temperature. It's determined as $P_{D(max)}=(T_{J(max)} - T_A)/R_{TH(j-a)}$ where $T_{J(max)}$: maximum chip junction temperature is usually considered as 150°C, T_A: ambient temperature, $R_{TH(j-a)}$: thermal resistance. Since P=IV, for sinking larger I_{PN}, users had better add proper voltage reducers on outputs to reduce the heat generated from the SCT2001.



Limitation on Maximum Output Current

The maximum output current vs. duty cycle is estimated by:

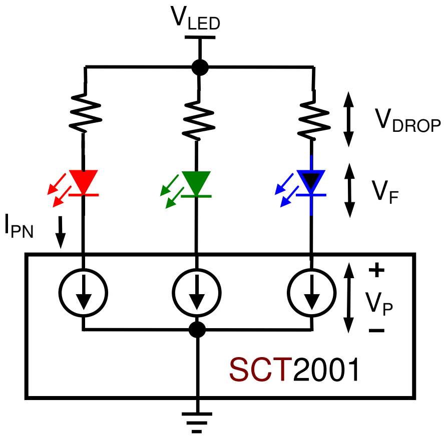
$I_{PN(max)}=(((T_{J(max)}-T_A)/R_{TH(j-a)})-(V_{DD}*I_{DD}))/V_P/Duty/N$ Where $T_{J(max)}$=150°C, N=3 (all ON)

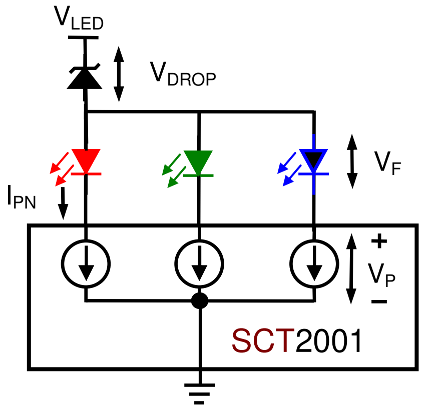


Load Supply Voltage (V_{LED})

The SCT2001 can be operated very well when V_P ranges from 1V to V_{P_MAX}. However, it is recommended to use the lowest possible supply voltage or set a voltage reducer to reduce the V_P voltage, at the same time reduce the power dissipation of the SCT2001. The following diagram shows ways to lower down the output voltage by adding additional resistor or zener diode, thus

$V_P = V_{LED}-V_{DROP}-V_F$.





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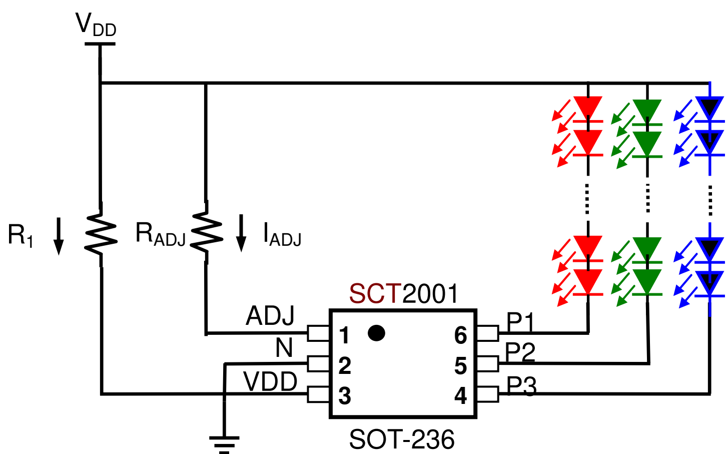
Over Temperature Shutdown

The SCT2001 contains thermal shutdown scheme to prevent damage from over-heating. The internal thermal sensor turns off input current of all channels when the die temperature exceeds +160°C. The LEDs are turned on again when the die temperature drops below +110°C. During the thermal shutdown process, the LEDs look blinking since it is turned OFF then ON periodically.

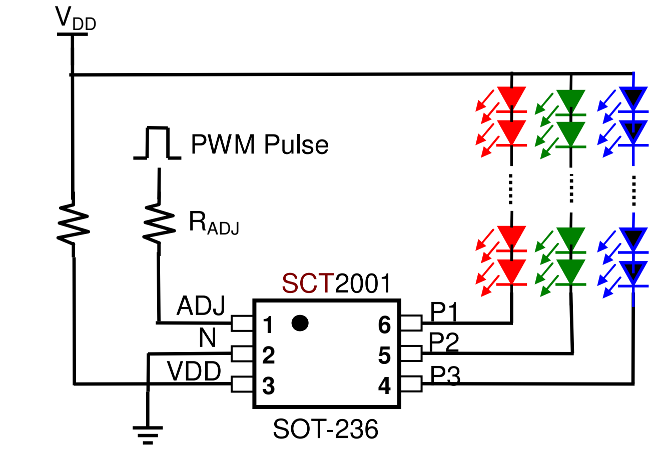
Typical Application Circuits

(1) RGB LED Lighting



The SCT2001 can operate with wide supply input range by shunting a resistor R_1 to V_{DD}. The calculation of R_1 is approximately expressed by: $R_1 = (V_{DD}-5V)/I_{DD(max)}(1.5\ mA)$, the R_1 at least 2K from supply input to the SCT2001 is required. For example, if $V_{DD}=24V$, set $R_1 = (24V-5V)/I_{DD(max)}(1.5mA) = 12.5K$. If $V_{DD}=5V$, set $R_1=2K$ directly.

(2) Lighting with dimming control

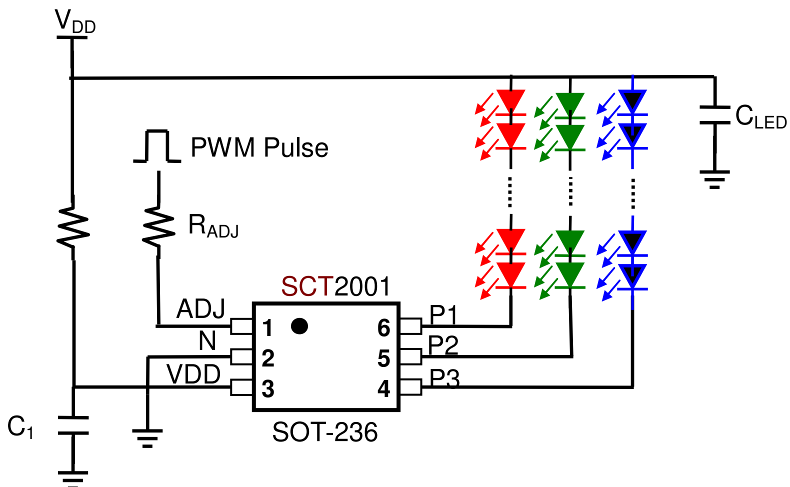


PCB Design Considerations

Use the following general guide-line when designing printed circuit boards **(**PCB**) :**

It is recommended to place capacitors C_1= 0.1uF and C_{LED}=10uF as shown.

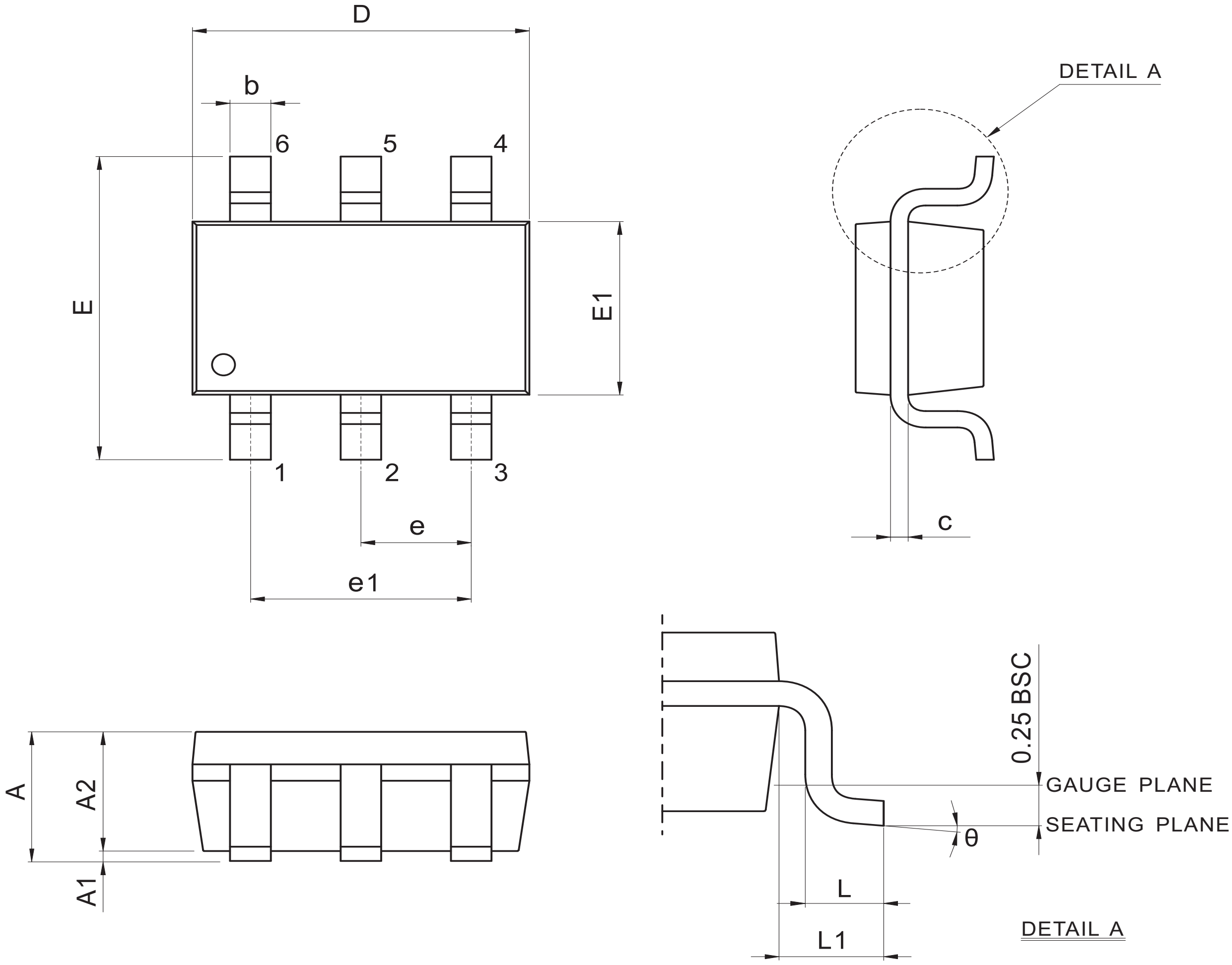
Locate the decoupling capacitor 0.1uF as close to the SCT2001 as possible. The necessary capacitance depends on the LED load current and dimming frequency. Inadequate V_{DD} decoupling can cause timing problems, and very noisy LED supplies can affect LED current regulation.



Maximizing the width and minimizing the length of VDD and GND trace improves efficiency and ground bouncing. Adding a capacitor C_{LED} greater than 10uF beside the LED is recommended.

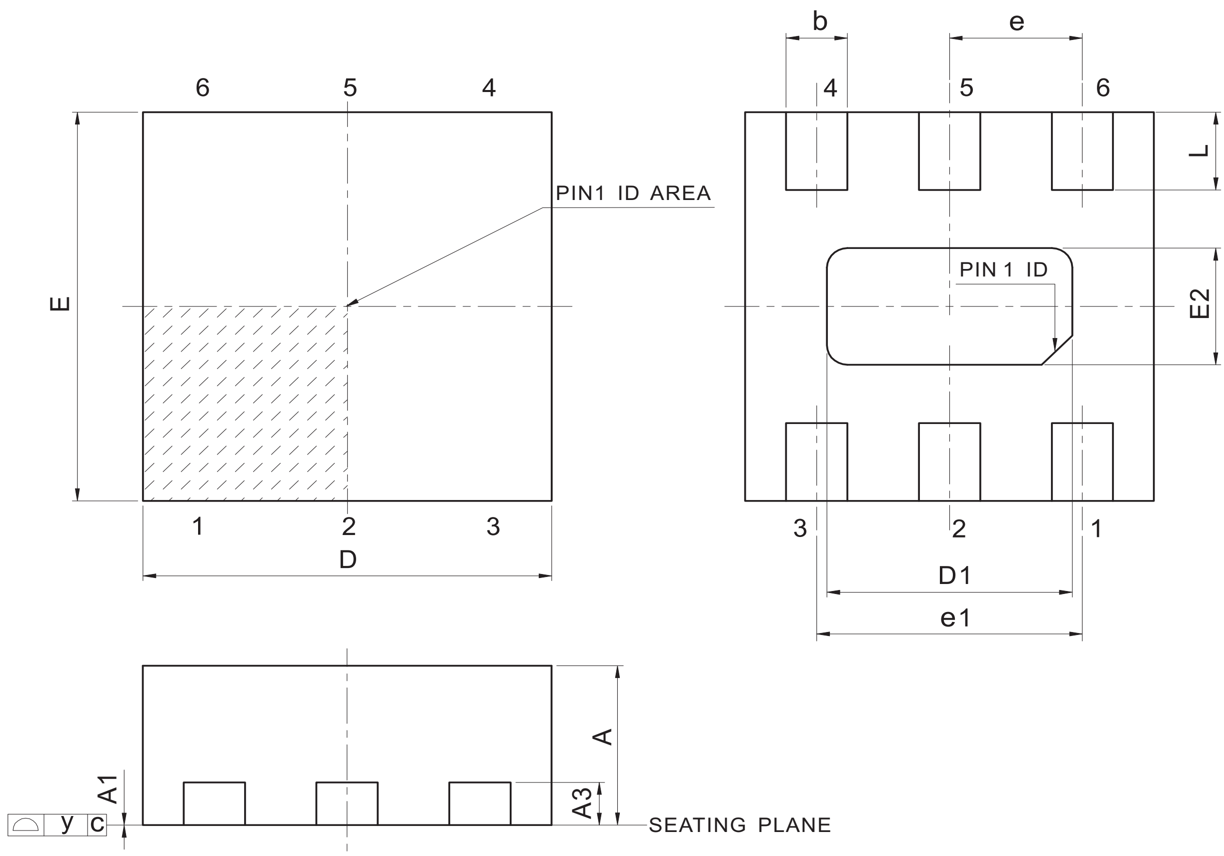
Package Dimension

SOT-236



Symbol	Dimension (mm)			Dimension (mil)		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	-	-	1.45	-	-	57.1
A1	0.00	-	0.15	0.0	-	5.9
A2	0.90	1.15	1.30	35.4	45.3	51.2
b	0.30	-	0.50	11.8	-	19.7
c	0.08	-	0.22	3.2	-	8.7
D	2.90 BSC			114.2 BSC		
E	2.80 BSC			110.2 BSC		
E1	1.60 BSC			63.0 BSC		
e	0.95 BSC			37.4 BSC		
e1	1.90 BSC			74.8 BSC		
L	0.30	0.45	0.60	11.8	17.7	23.6
L1	0.60 REF			23.6 REF		
θ	0°	4°	8°	0°	4°	8°

DFN6-2x2



Symbol	Dimension (mm)			Dimension (mil)		
	Min.	Nom.	Max.	Min.	Nom.	Max.
A	0.70	0.75	0.80	27.6	29.5	31.5
A1	0.00	0.02	0.05	0.0	0.8	2.0
A3	0.20 REF			7.9 REF		
b	0.20	0.30	0.40	7.9	11.8	15.7
D	1.9	2.00	2.10	74.8	78.7	82.7
D1	0.00	1.20	1.25	0.0	47.2	49.2
E	1.9	2.00	2.10	74.8	78.7	82.7
E2	0.00	0.60	0.65	0.0	23.6	25.6
e	0.65 BSC			25.6 BSC		
e1	1.30 BSC			51.2 BSC		
L	0.40 REF			15.7 REF		
y	-	-	0.08	-	-	3.1

Revision History

Data Sheet Version	Remark
V02_03	Add R1 to VDD pin at testing & application circuit
V03_01	Rename pins